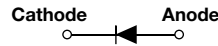


## Schottky Rectifier, 2.1 A



SMA



### FEATURES

- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level


**RoHS**  
COMPLIANT

### PRODUCT SUMMARY

$I_{F(AV)}$	2.1 A
$V_R$	60 V

### DESCRIPTION

The VS-20MQ060NPbF surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

### MAJOR RATINGS AND CHARACTERISTICS

SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform	2.1	A
$V_{RRM}$		60	V
$I_{FSM}$	$t_p = 5 \mu s$ sine	40	A
$V_F$	2 Apk, $T_J = 125^\circ C$	0.68	V
$T_J$	Range	- 55 to 150	$^\circ C$

### VOLTAGE RATINGS

PARAMETER	SYMBOL	VS-20MQ060NPbF	UNITS
Maximum DC reverse voltage	$V_R$	60	V
Maximum working peak reverse voltage	$V_{RWM}$		

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current See fig. 4	$I_{F(AV)}$	50 % duty cycle at $T_C = 107^\circ C$ , rectangular waveform On PC board 9 mm <sup>2</sup> island (0.013 mm thick copper pad area)	2.1	A
Maximum peak one cycle non-repetitive surge current See fig. 6	$I_{FSM}$	5 $\mu s$ sine or 3 $\mu s$ rect. pulse	40	A
		10 ms sine or 6 ms rect. pulse		
Non-repetitive avalanche energy	$E_{AS}$	$T_J = 25^\circ C$ , $I_{AS} = 1 A$ , $L = 4 mH$	2.0	mJ
Repetitive avalanche current	$I_{AR}$	Current decaying linearly to zero in 1 $\mu s$ Frequency limited by $T_J$ maximum $V_A = 1.5 \times V_R$ typical	1.0	A

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop See fig. 1	$V_{FM}^{(1)}$	2 A	$T_J = 25\text{ }^\circ\text{C}$	0.78	V
		1.5 A		0.71	
		1 A		0.63	
		2 A	$T_J = 125\text{ }^\circ\text{C}$	0.68	
		1.5 A		0.63	
		1 A		0.57	
Maximum reverse leakage current See fig. 2	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	$V_R = \text{Rated } V_R$	0.5	mA
		$T_J = 125\text{ }^\circ\text{C}$		7.5	
Threshold voltage	$V_{F(TO)}$	$T_J = T_J \text{ maximum}$		0.45	V
Forward slope resistance	$r_t$			86.8	m $\Omega$
Typical junction capacitance	$C_T$	$V_R = 10\text{ V}_{DC}, T_J = 25\text{ }^\circ\text{C}, \text{ test signal} = 1\text{ MHz}$		31	pF
Typical series inductance	$L_S$	Measured lead to lead 5 mm from package body		2.0	nH
Maximum voltage rate of change	dV/dt	Rated $V_R$		10 000	V/ $\mu$ s

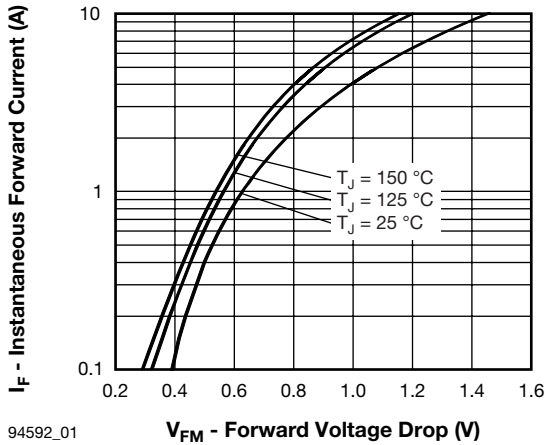
**Note**

(1) Pulse width < 300  $\mu$ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction and storage temperature range	$T_J^{(1)}, T_{Stg}$			- 55 to 150	$^\circ\text{C}$
Maximum thermal resistance, junction to ambient	$R_{thJA}$	DC operation		80	$^\circ\text{C/W}$
Approximate weight				0.07	g
				0.002	oz.
Marking device		Case style SMA (similar D-64)		V2H	

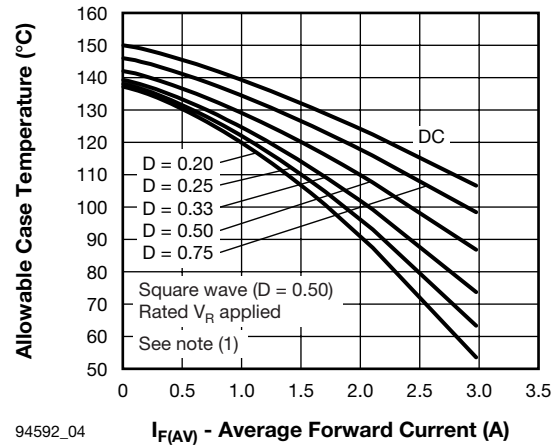
**Note**

(1)  $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$  thermal runaway condition for a diode on its own heatsink



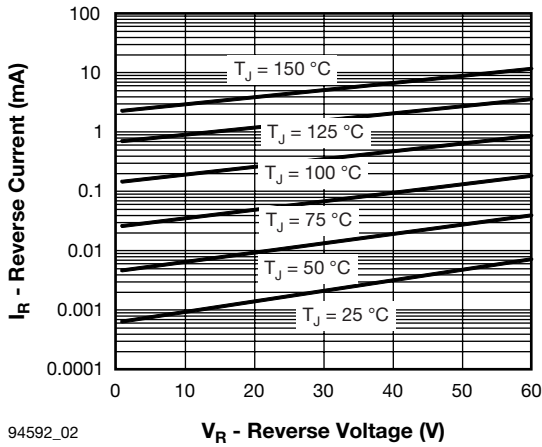
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Fig. 1 - Maximum Forward Voltage Drop Characteristics



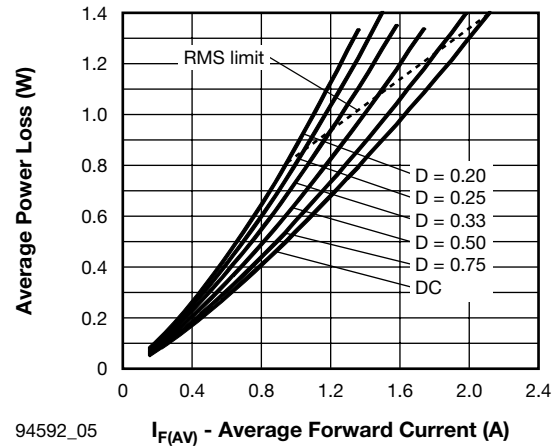
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Fig. 4 - Maximum Average Forward Current vs. Allowable Lead Temperature



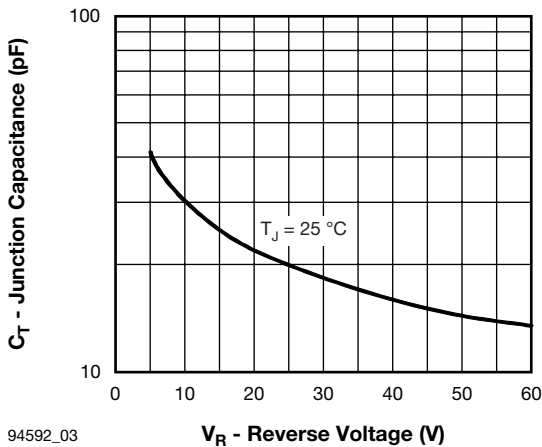
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Fig. 2 - Typical Peak Reverse Current vs. Reverse Voltage



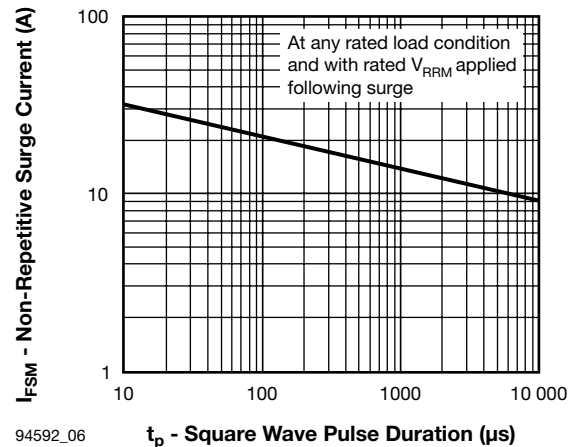
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Fig. 5 - Maximum Average Forward Dissipation vs. Average Forward Current



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Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage



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Fig. 6 - Maximum Peak Surge Forward Current vs. Pulse Duration

**Note**

(1) Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;  
 $Pd$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  $Pd_{REV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1} = 80\%$  rated  $V_R$

## ORDERING INFORMATION TABLE

Device code	<b>VS-</b>	<b>20</b>	<b>M</b>	<b>Q</b>	<b>060</b>	<b>N</b>	<b>TR</b>	<b>PbF</b>
	①	②	③	④	⑤	⑥	⑦	⑧

- 1** - HPP product suffix
- 2** - Current rating
- 3** - M = SMA
- 4** - Q = Schottky "Q" series
- 5** - Voltage rating (060 = 60 V)
- 6** - N = New SMA
- 7** -
  - None = Box (1000 pieces)
  - TR = Tape and reel (7500 pieces)
- 8** - PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95018">www.vishay.com/doc?95018</a>
Part marking information	<a href="http://www.vishay.com/doc?95029">www.vishay.com/doc?95029</a>
Packaging information	Tape and reel
	Bulk
SPIICE model	<a href="http://www.vishay.com/doc?95396">www.vishay.com/doc?95396</a>



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